DESCRIPTION

The SPN2318 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

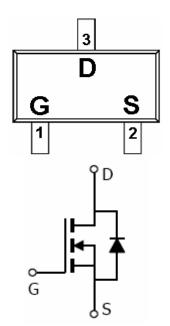
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

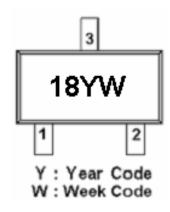
FEATURES

- 40V/3.9A, RDS(ON)= $56m\Omega$ @VGS=10V
- \bullet 40V/3.5A,RDS(ON)= 62m Ω (α)VGS=4.5V
- 40V/2.0A, RDS(ON)= $95 \text{ m}\Omega$ @VGS= 2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-3L package design

PIN CONFIGURATION (SOT-23-3L)



PART MARKING



PIN DESCRIPTION					
Pin	Symbol	Description			
1	G	Gate			
2	S	Source			
3	D	Drain			

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN2318S23RGB	SOT-23-3L	18YW

% Week Code : $A \sim Z(1 \sim 26)$; $a \sim z(27 \sim 52)$

※ SPN2318S23RGB: Tape Reel; Pb − Free; Halogen - Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

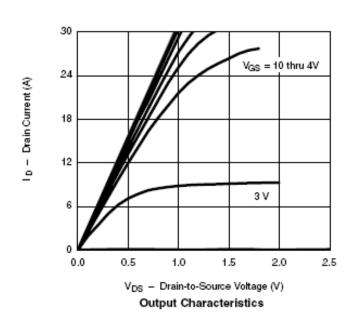
Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	40	V	
Gate –Source Voltage		VGSS	±12	V	
Continuous Proin Compant(Ty-150°C)	TA=25°C	In	4.0	Δ.	
Continuous Drain Current(TJ=150°C)	TA=70°C	- Id	3.0	A	
Pulsed Drain Current	Ірм	10	A		
Continuous Source Current(Diode Conduction)		Is	1.25	A	
Danier Diagination	TA=25°C	PD	1.25	· · · · · · · · · · · · · · · · · · ·	
Power Dissipation	TA=70°C		0.8	W	
Operating Junction Temperature		Тл	150	$^{\circ}\mathbb{C}$	
Storage Temperature Range		Tstg	-55/150	$^{\circ}\mathbb{C}$	
Thermal Resistance-Junction to Ambient		R _θ JA	100	°C/W	

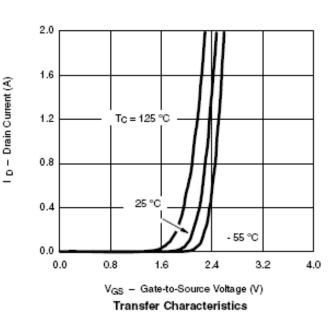
ELECTRICAL CHARACTERISTICS

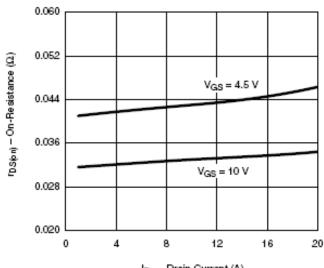
(TA=25°C Unless otherwise noted)

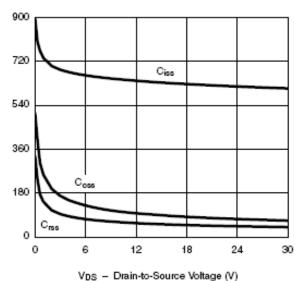
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	•			•	•		
Drain-Source Breakdown Voltage	V(BR)DSS	V _{GS} =0V,I _D =250uA	40			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.5		1.2	\ \ \ \ \ \	
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±12V			±100	nA	
		V _{DS} =40V,V _{GS} =0V			1		
Zero Gate Voltage Drain Current	Idss	V _{DS} =40V,V _{GS} =0V T _J =85°C			5	uA	
On-State Drain Current	ID(on)	V_{DS} = 5V, V_{GS} =4.5V	10			A	
	RDS(on)	V _G S= 10V,I _D =3.9A		0.050	0.056	Ω	
Drain-Source On-Resistance		VGS=4.5V,ID=3.5A		0.056	0.062		
		V _{GS} =2.5V,I _D =2.0A		0.088	0.095		
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S	
Diode Forward Voltage	Vsd	Is=2.3A,V _{GS} =0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			16	24	nC	
Gate-Source Charge	Qgs	V _{DS} =15V,V _{GS} =10V I _D = 2A		3			
Gate-Drain Charge	Qgd	10 211		2.5		1	
Turn-On Time	td(on)			15	20	nS	
	tr	V _{DD} =15V,R _L =15Ω		6	12		
T Off Time	td(off)	$I_{D}\equiv 1.0A, V_{GEN}=10V$ $R_{G}=6\Omega$		10	20		
Turn-Off Time	tf			40	80		

TYPICAL CHARACTERISTICS









I_D - Drain Current (A)
On-Resistance vs. Drain Current and Gate Voltage

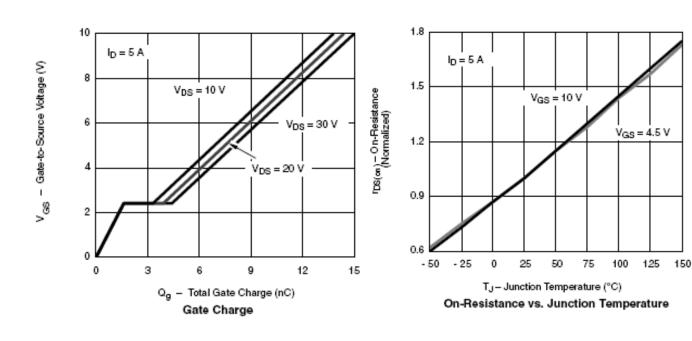
Vps - Drain-to-Source Voltage (V)

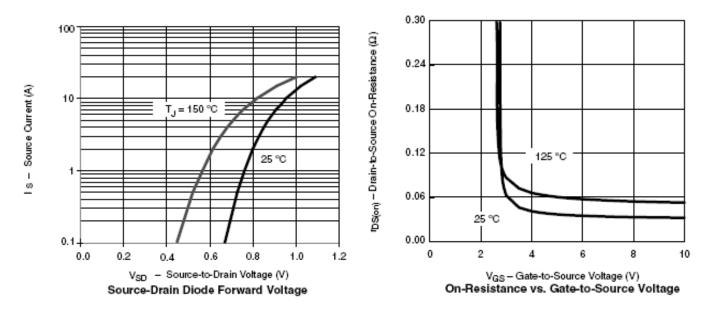
Capacitance

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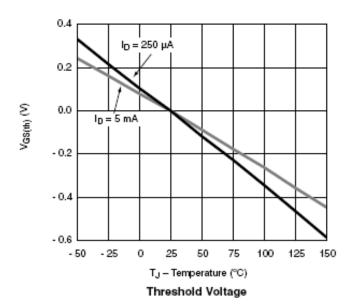
C - Capacitance (pF)

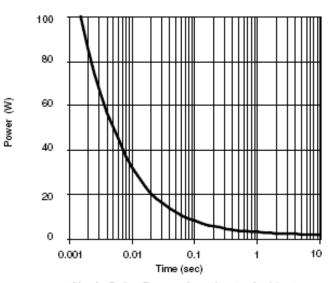
TYPICAL CHARACTERISTICS



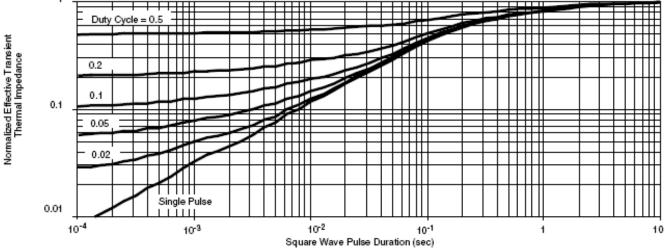


TYPICAL CHARACTERISTICS





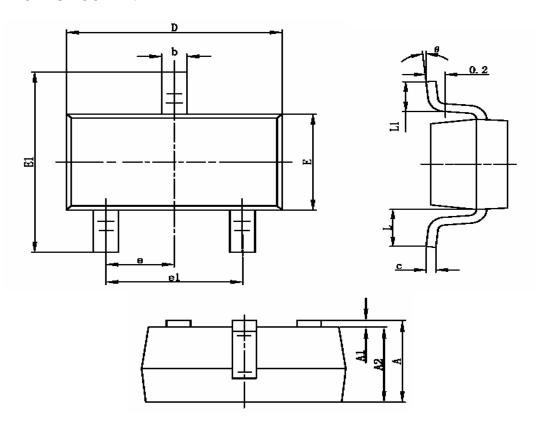
Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23-3L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.400	0.012	0.016	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950TYP		0.03	7TYP	
e1	1.800	2.000	0.071	0.079	
L	0.700REF		0.028REF		
L1	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

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